



RF360  
Europe GmbH

## Data sheet

SAW duplexer  
LTE band 71

Part number:	M5303
Ordering code:	B39681M5303D310
Date:	March 14, 2022
Version:	2.2

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## 1 Application

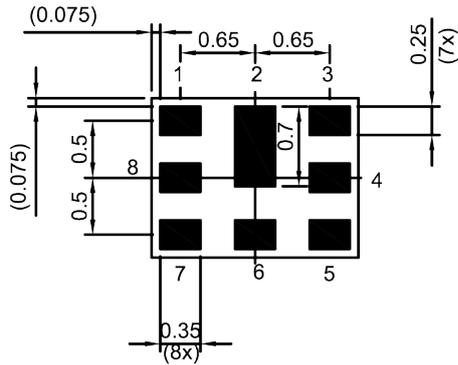
- Duplexer for LTE band 71
- LTE band 71 uplink: 680.5 MHz (pass band 35 MHz)
- LTE band 71 downlink: 634.5 MHz (pass band 35 MHz)

## 2 Features

- Package size  $1.8_{\pm 0.05}$  mm  $\times$   $1.4_{\pm 0.05}$  mm
- Package height  $0.61_{\pm 0.032}$  mm
- Approximate weight 4 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)
- AEC-Q200 qualified component family  
(Grade 1:  $-40$  °C to  $+125$  °C)

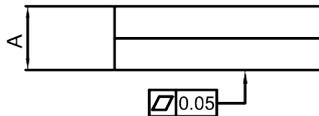
### 3 Package

BOTTOM VIEW

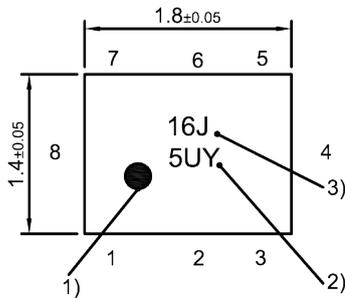


Pad and Pitch Tolerance  $\pm 0.05$

SIDE VIEW

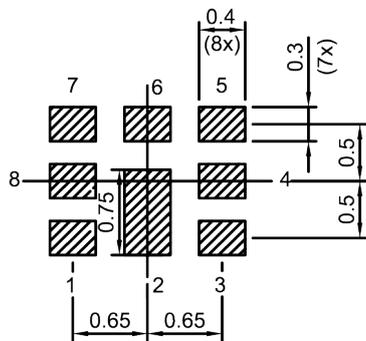


TOP VIEW



- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number

Land pattern  
THRU VIEW



Landing pad tolerance  $-0.02$

**Figure 1:** Drawing of package with package height  $A = 0.61 \pm 0.032$  mm. See Sec. Package information (p. 21).

### 4 Pin configuration

- 1 RX
- 3 TX
- 6 ANT
- 2, 4, 5, 7, 8 Ground

5 Matching circuit

- $L_{p6} = 18 \text{ nH}$

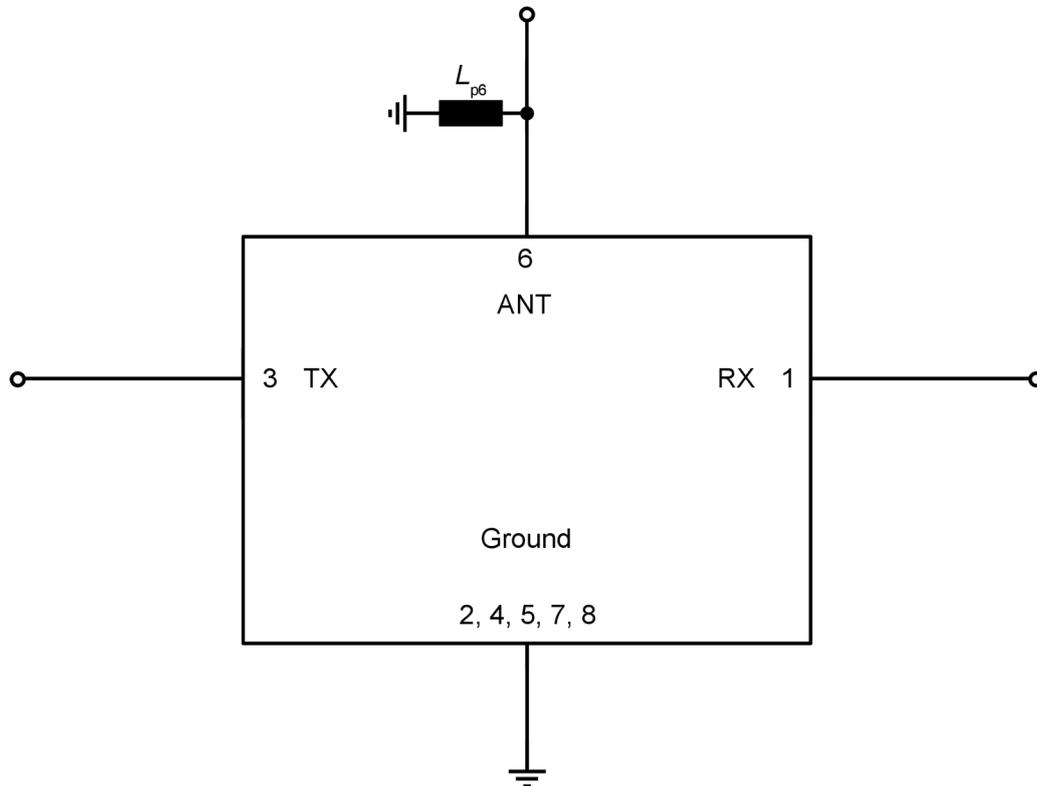


Figure 2: Schematic of matching circuit.

## 6 Characteristics

### 6.1 TX – ANT

Temperature range for specification	$T_{SPEC}$	= -30 °C ... +85 °C
TX terminating impedance	$Z_{TX}$	= 50 Ω
ANT terminating impedance	$Z_{ANT}$	= 50 Ω // 18 nH <sup>1)</sup>
RX terminating impedance	$Z_{RX}$	= 50 Ω

Characteristics TX – ANT				min. for $T_{SPEC}$	typ. @ +25 °C	max. for $T_{SPEC}$	
<b>Center frequency</b>			$f_C$	—	680.5	—	MHz
<b>Maximum insertion attenuation</b>							
	663... 698	MHz	$\alpha_{INT,max}^{2)}$	—	1.5	2.2	dB
	663.34... 697.66	MHz	$\alpha_{max}$	—	2.0	2.7 <sup>3)</sup>	dB
	663.34... 697.66	MHz	$\alpha_{max}$	—	2.0	3.0	dB
<b>Amplitude ripple (p-p)</b>			$\Delta\alpha^{4)}$				
	663.34... 697.66	MHz		—	1.2	2.2	dB
<b>Maximum VSWR</b>			$VSWR_{max}$				
@ TX port	663.34... 697.66	MHz		—	1.5	2.0	
@ ANT port	663.34... 697.66	MHz		—	1.5	2.0	
<b>Minimum attenuation</b>			$\alpha_{min}$				
	50... 608	MHz		36	46	—	dB
	608... 614	MHz		50	56	—	dB
	617.34... 651.66	MHz		48	58	—	dB
	717... 729	MHz		30	45	—	dB
	729... 768	MHz		54	58	—	dB
	768... 805	MHz		45	55	—	dB
	824... 849	MHz		30	40	—	dB
	859... 894	MHz		38	43	—	dB
	1164... 1396	MHz		40	46	—	dB
	1559... 1606	MHz		50	55	—	dB
	1710... 1755	MHz		50	55	—	dB
	1805... 2094	MHz		45	55	—	dB
	2110... 2200	MHz		50	55	—	dB
	2400... 2792	MHz		45	55	—	dB
	3300... 4200	MHz		35	42	—	dB
	4400... 5000	MHz		25	33	—	dB
	5000... 5925	MHz		17	22	—	dB

<sup>1)</sup> See Sec. Matching circuit (p. 6).

<sup>2)</sup> Integrated attenuation  $\alpha_{INT}$ : Averaged power  $|S_{ij}|^2$  over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

<sup>3)</sup> Valid for typical temperature  $T = +25$  °C.

<sup>4)</sup> Over any 5 MHz.

## 6.2 ANT – RX

Temperature range for specification	$T_{SPEC}$	= -30 °C ... +85 °C
TX terminating impedance	$Z_{TX}$	= 50 $\Omega$
ANT terminating impedance	$Z_{ANT}$	= 50 $\Omega$ // 18 nH <sup>1)</sup>
RX terminating impedance	$Z_{RX}$	= 50 $\Omega$

Characteristics ANT – RX				min. for $T_{SPEC}$	typ. @ +25 °C	max. for $T_{SPEC}$	
<b>Center frequency</b>			$f_C$	—	634.5	—	MHz
<b>Maximum insertion attenuation</b>							
	617... 652	MHz	$\alpha_{INT,max}^{2)}$	—	1.6	2.3	dB
	617.34... 651.66	MHz	$\alpha_{max}$	—	2.0	2.7 <sup>3)</sup>	dB
	617.34... 651.66	MHz	$\alpha_{max}$	—	2.0	3.3	dB
<b>Amplitude ripple (p-p)</b>			$\Delta\alpha^{4)}$				
	617.34... 651.66	MHz		—	1.2	2.5	dB
<b>Maximum VSWR</b>			VSWR <sub>max</sub>				
@ ANT port	617.34... 651.66	MHz		—	1.6	2.0	
@ RX port	617.34... 651.66	MHz		—	1.7	2.1	
<b>Average attenuation</b>			$\alpha_{avg}$				
	657.56... 662.44	MHz		—	30 <sup>5)</sup>	—	dB
<b>Minimum attenuation</b>			$\alpha_{min}$				
	50... 590	MHz		30	34	—	dB
	663.34... 697.66	MHz		45	52	—	dB
	717... 740	MHz		30	34	—	dB
	776... 805	MHz		32	34	—	dB
	824... 849	MHz		30	34	—	dB
	1058... 1484	MHz		33	35	—	dB
	1653... 1956	MHz		35	42	—	dB
	2305... 2967	MHz		35	39	—	dB
	3300... 4200	MHz		30	35	—	dB
	4317... 4400	MHz		25	32	—	dB
	4400... 5950	MHz		15	19	—	dB
	5855... 5925	MHz		19	23	—	dB

<sup>1)</sup> See Sec. Matching circuit (p. 6).

<sup>2)</sup> Integrated attenuation  $\alpha_{INT}$ : Averaged power  $|S_{ij}|^2$  over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

<sup>3)</sup> Valid for typical temperature  $T = +25$  °C.

<sup>4)</sup> Over any 5 MHz.

<sup>5)</sup> Over any channel with band width of 4.875MHz.

### 6.3 TX – RX

Temperature range for specification

$$T_{SPEC} = -30\text{ °C} \dots +85\text{ °C}$$

TX terminating impedance

$$Z_{TX} = 50\ \Omega$$

ANT terminating impedance

$$Z_{ANT} = 50\ \Omega // 18\text{ nH}^{1)}$$

RX terminating impedance

$$Z_{RX} = 50\ \Omega$$

Characteristics TX – RX				min. for $T_{SPEC}$	typ. @ +25 °C	max. for $T_{SPEC}$	
<b>Minimum isolation</b>							
	$\alpha_{min}$						
		617.34... 651.66	MHz	55	60	—	dB
		663.34... 697.66	MHz	55	58	—	dB
		1326... 1396	MHz	50	55	—	dB
		1989... 2094	MHz	48	52	—	dB
		2652... 2792	MHz	45	50	—	dB

<sup>1)</sup> See Sec. Matching circuit (p. 6).

## 7 Maximum ratings

Operable temperature	$T_{OP} = -40\text{ °C} \dots +125\text{ °C}$	
Storage temperature	$T_{STG}^{1)} = -40\text{ °C} \dots +125\text{ °C}$	
DC voltage	$ V_{DC} ^{2)} = 0\text{ V (max.)}$	
Input power @ TX port: 663.34 ... 697.66 MHz	$P_{IN} = 29\text{ dBm (max.)}$	Continuous wave for 5000 h @ 50 °C.

<sup>1)</sup> Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

<sup>2)</sup> In case of applied DC voltage blocking capacitors are mandatory.

8 Transmission coefficients

8.1 TX – ANT

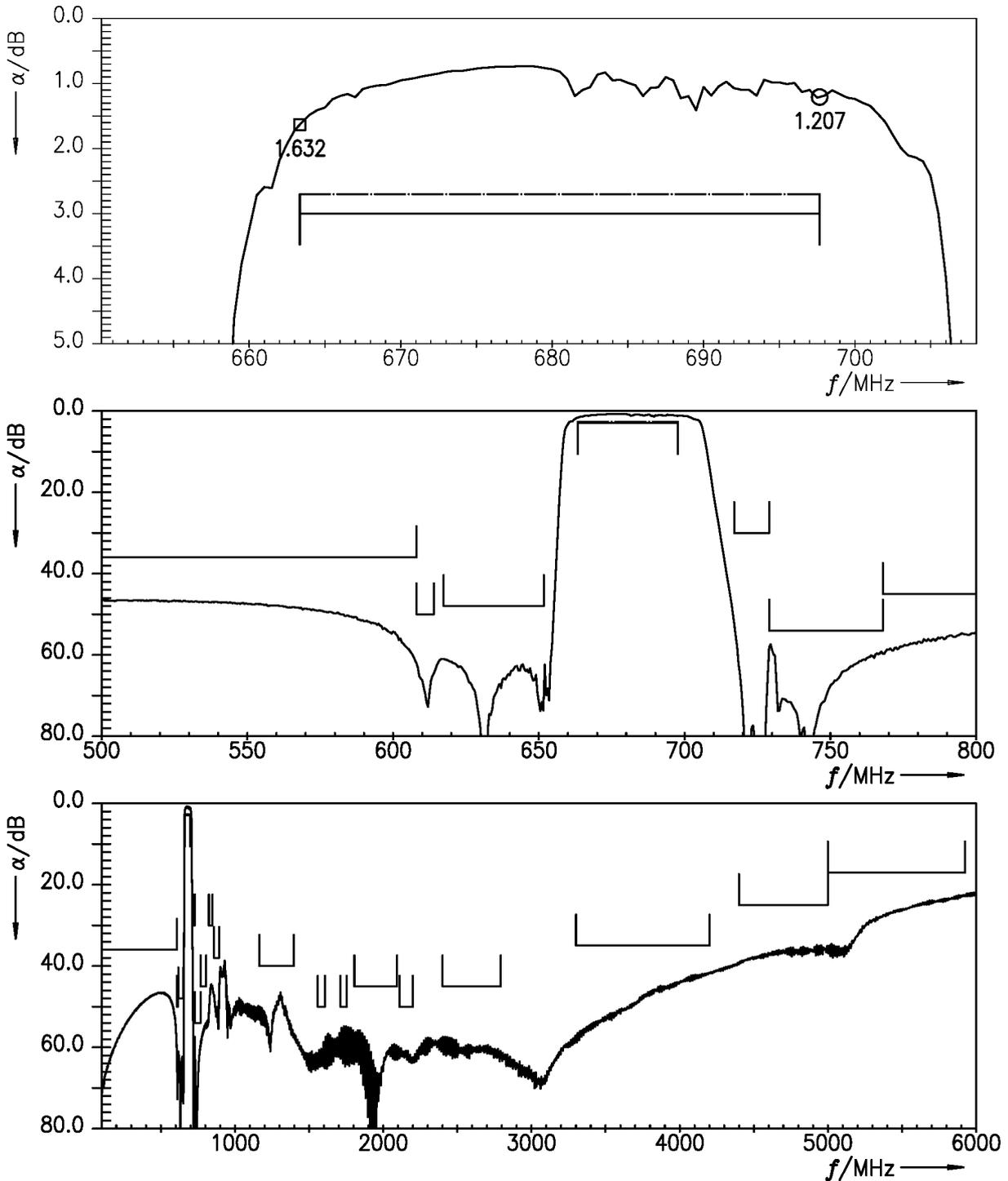


Figure 3: Attenuation TX – ANT.

8.2 ANT – RX

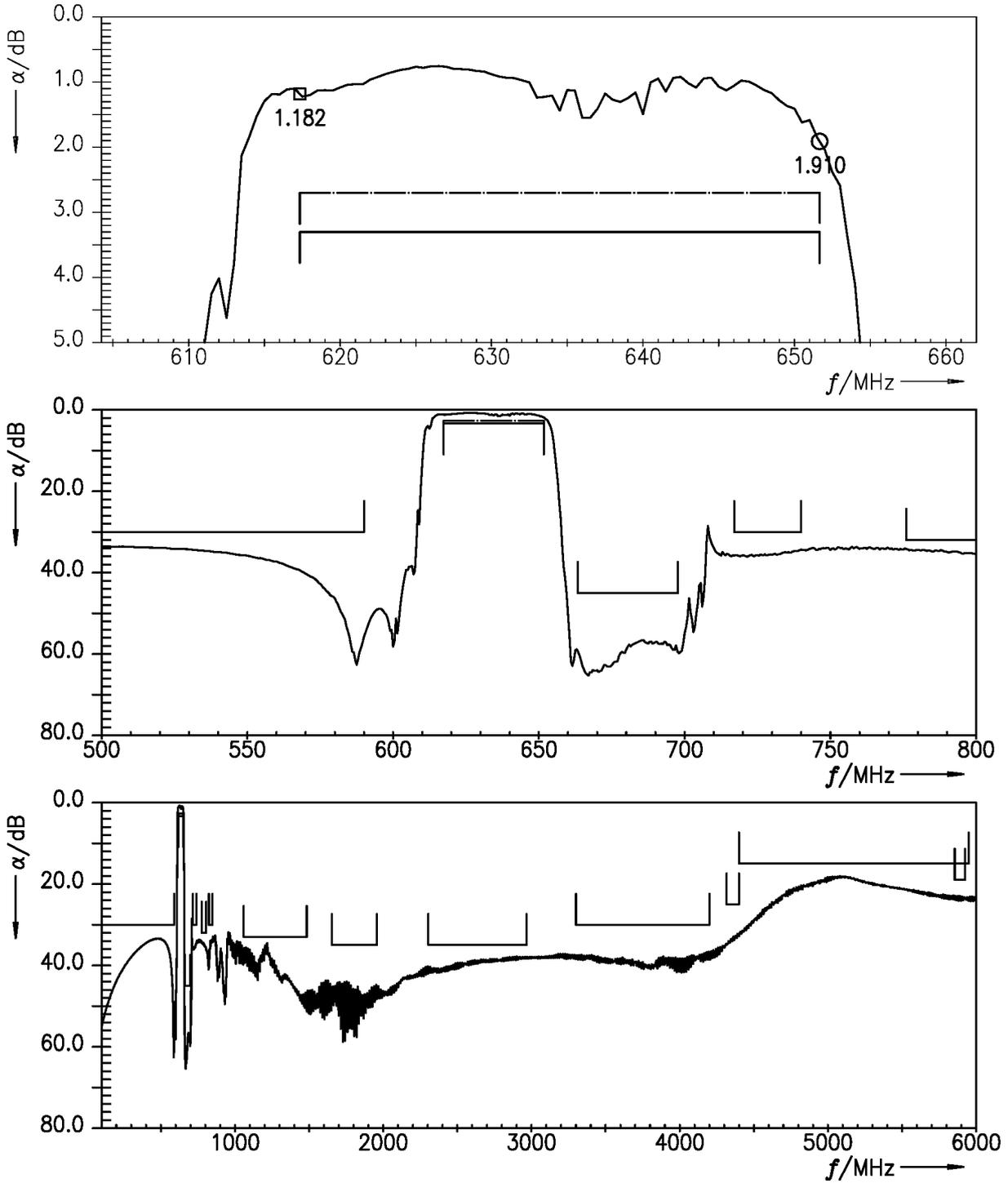


Figure 4: Attenuation ANT – RX.

8.3 TX – RX

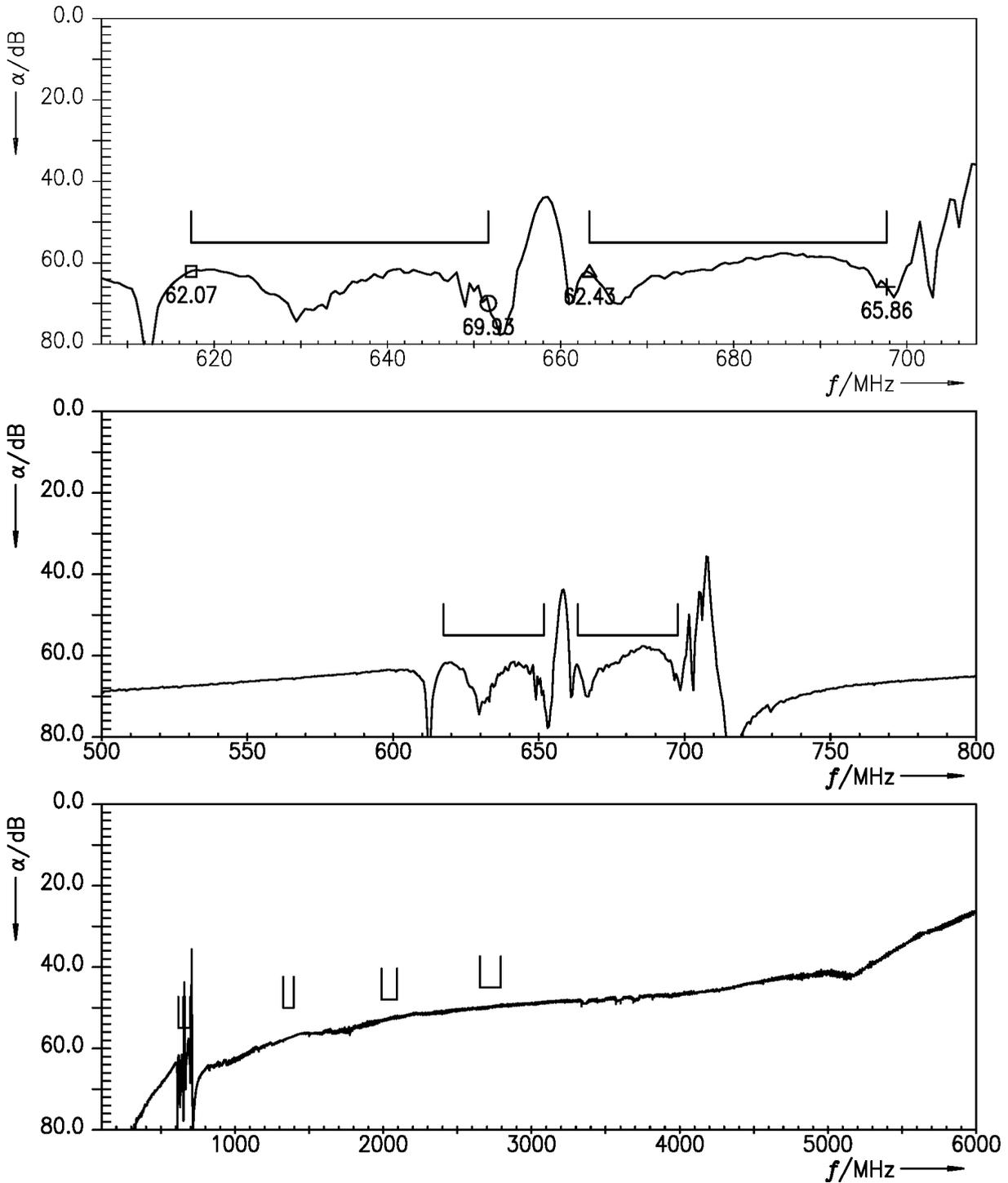


Figure 5: Isolation TX – RX.

9 Reflection coefficients

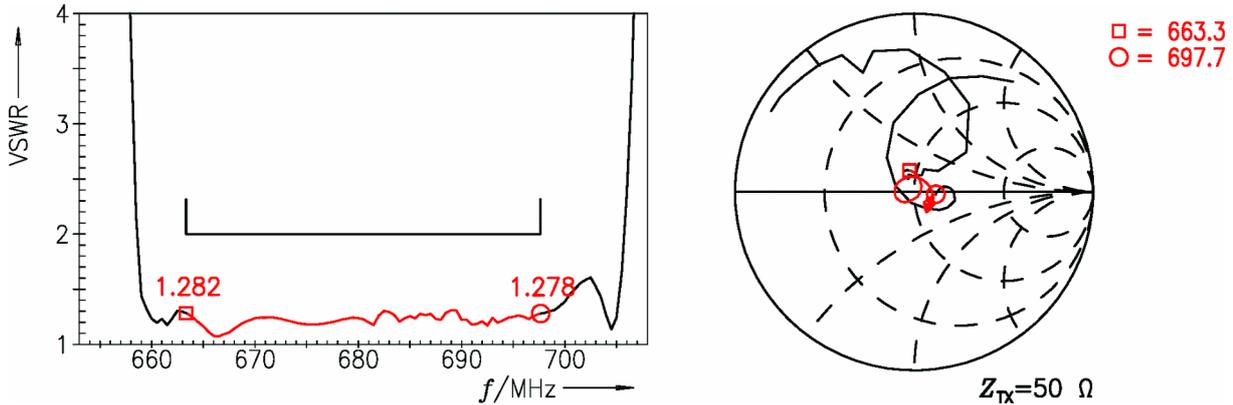


Figure 6: Reflection coefficient at TX port.

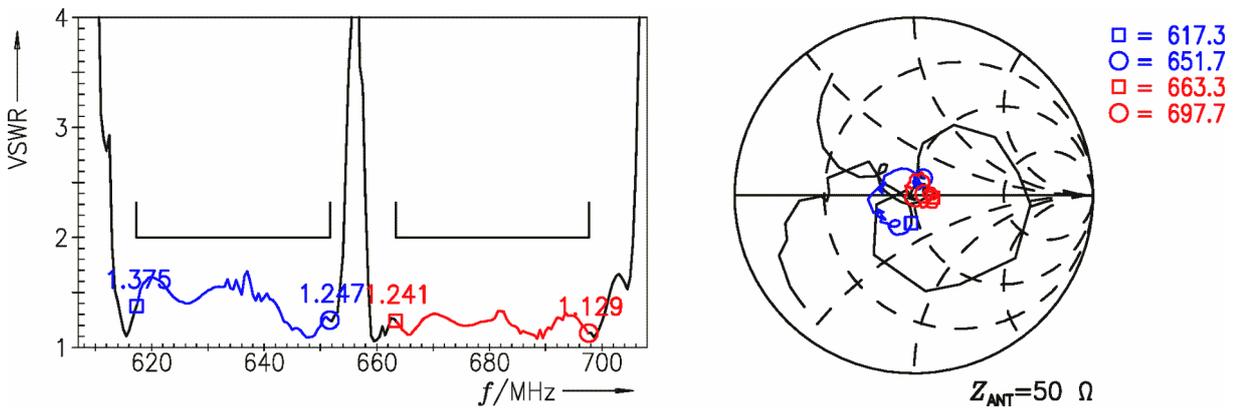


Figure 7: Reflection coefficient at ANT port (TX and RX frequencies).

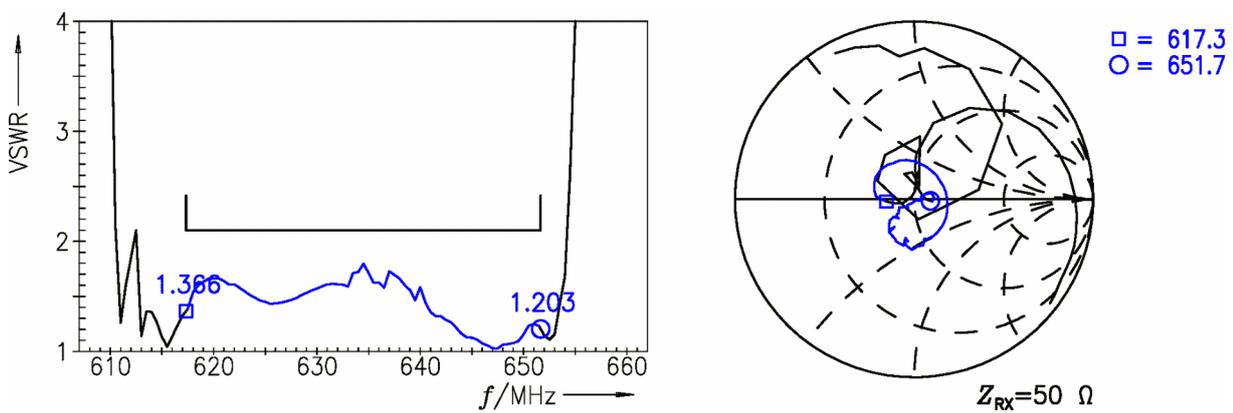
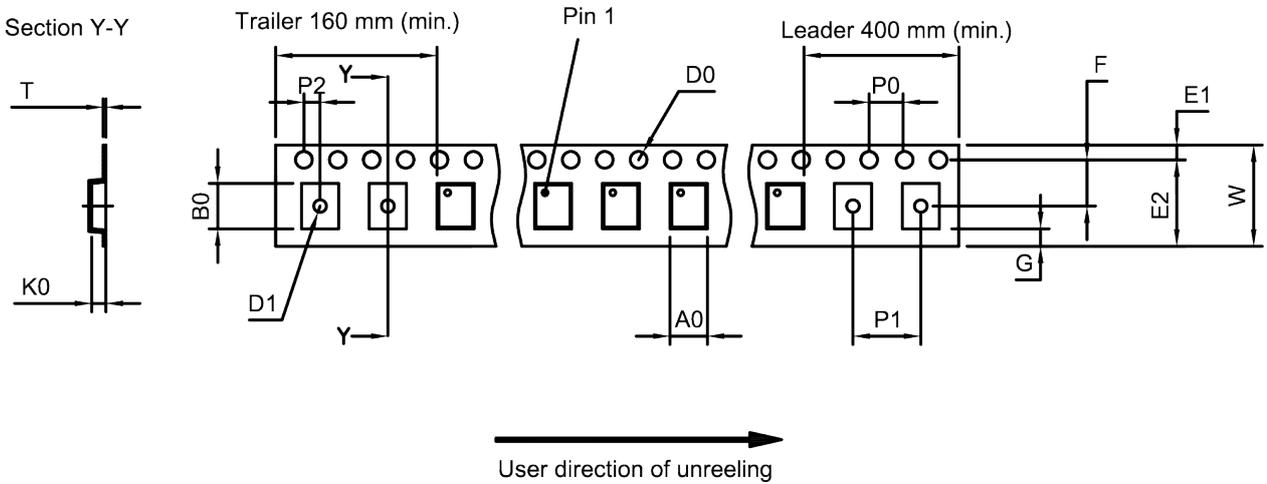


Figure 8: Reflection coefficient at RX port.

10 Packing material

10.1 Tape



**Figure 9:** Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A <sub>0</sub>	1.6±0.05 mm	E <sub>2</sub>	6.25 mm (min.)	P <sub>1</sub>	4.0±0.1 mm
B <sub>0</sub>	2.0±0.05 mm	F	3.5±0.05 mm	P <sub>2</sub>	2.0±0.05 mm
D <sub>0</sub>	1.5+0.1/-0 mm	G	0.75 mm (min.)	T	0.25±0.03 mm
D <sub>1</sub>	0.8+0.1/-0 mm	K <sub>0</sub>	0.8±0.1 mm	W	8.0-0.3/+0.1 mm
E <sub>1</sub>	1.75±0.1 mm	P <sub>0</sub>	4.0±0.1 mm		

**Table 1:** Tape dimensions.

10.2 Reel with diameter of 330 mm

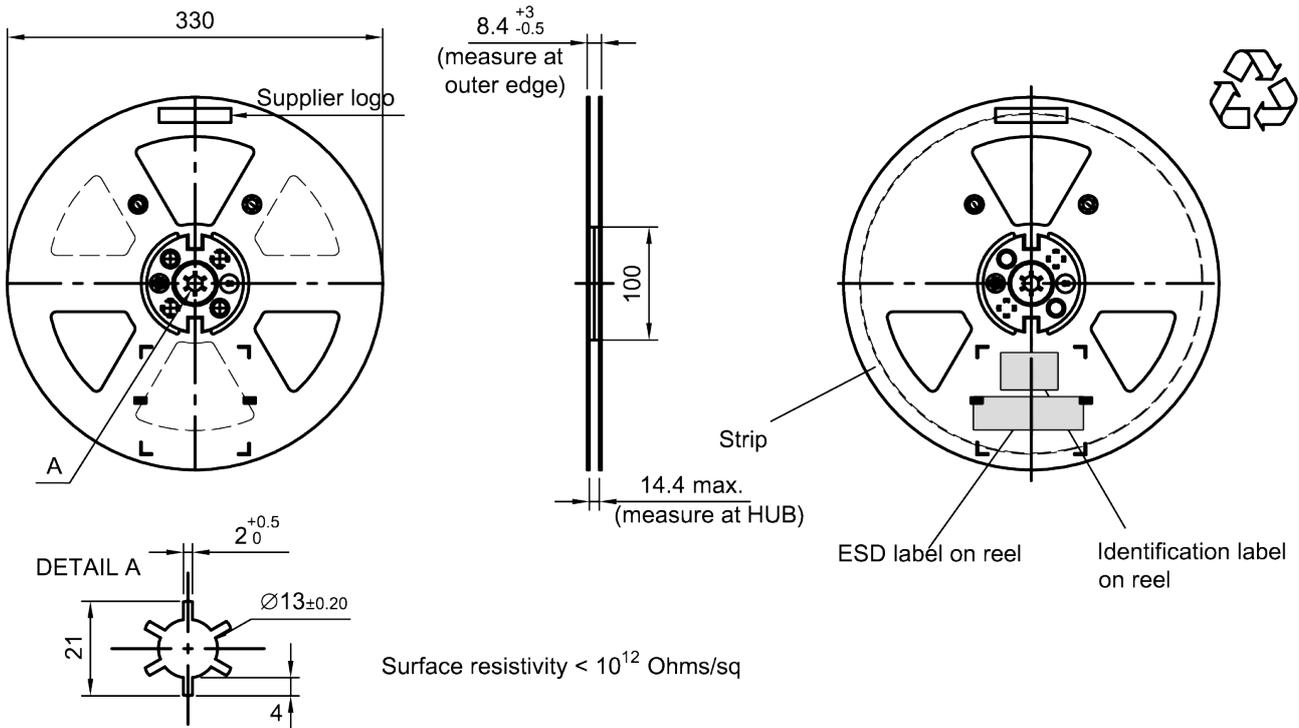


Figure 10: Drawing of reel (first-angle projection) with diameter of 330 mm.

Dimensions [mm]

X = 400+5

Y = 418+5

Sealing area 10±3

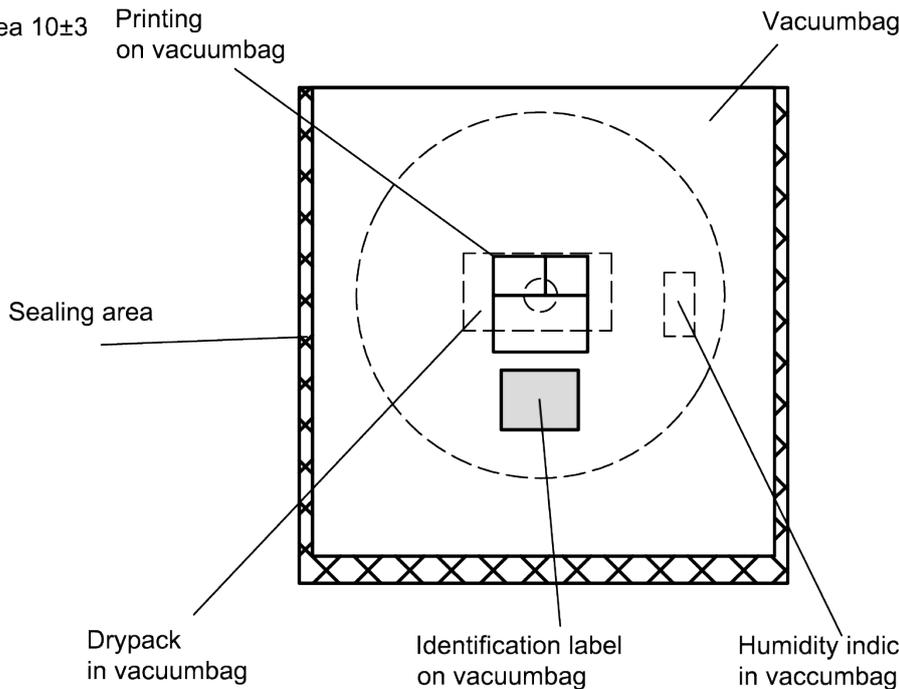
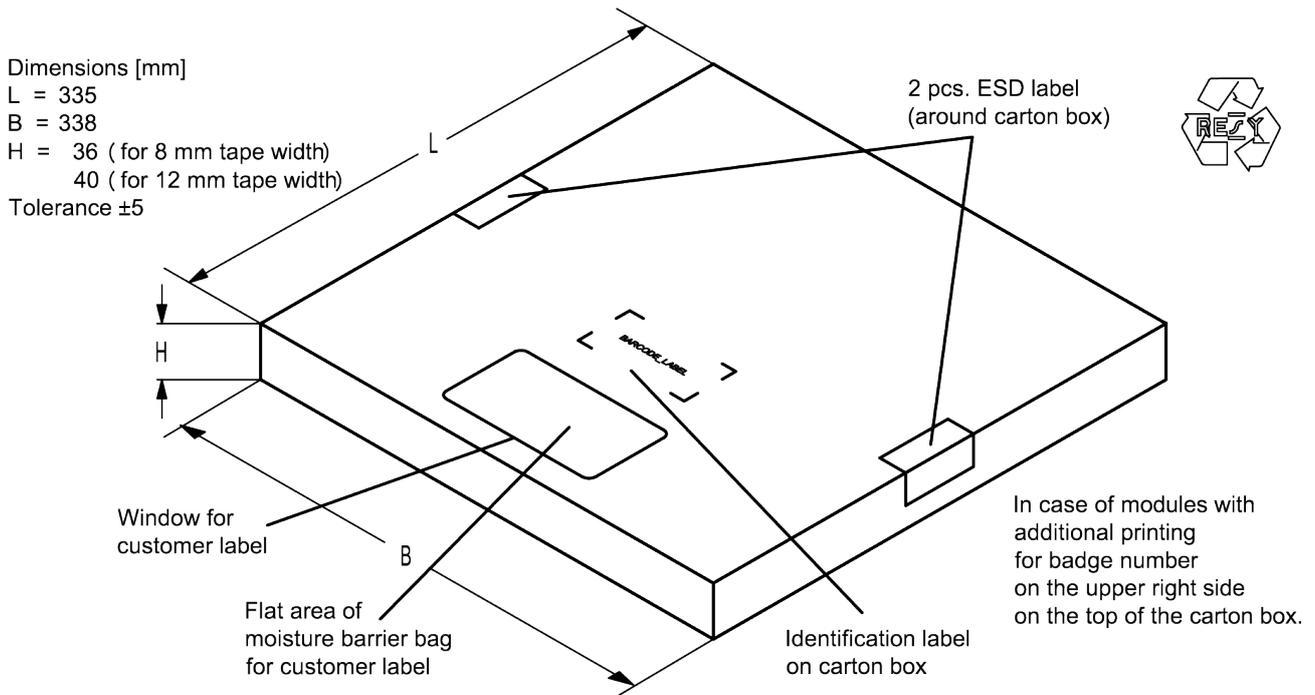


Figure 11: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.



**Figure 12:** Drawing of folding box for reel with diameter of 330 mm.

**11 Marking**

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx,  
is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.  
**16J** => **1234**  
 $1 \times 32^2 + 6 \times 32^1 + 18 (=J) \times 32^0 =$  **1234**  
 The BASE32 code for product type M5303 is 55Q.

■ Lot number:

The last 5 digits of the lot number, e.g., **12345**,  
are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.  
**5UY** => **12345**  
 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0 =$  **12345**

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

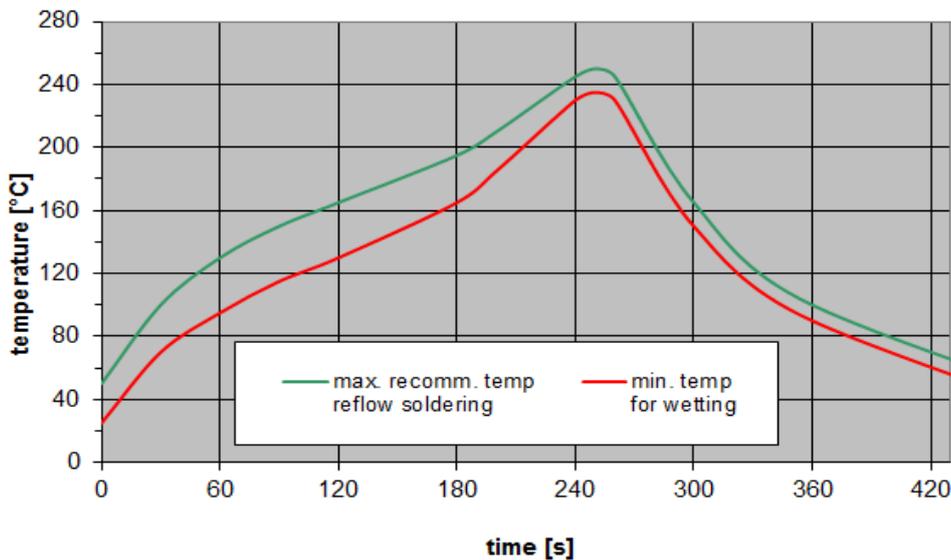
**Table 2:** Lists for encoding and decoding of marking.

## 12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3<sup>rd</sup> edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
$T > 220\text{ °C}$	30 s to 70 s
$T > 230\text{ °C}$	min. 10 s
$T > 245\text{ °C}$	max. 20 s
$T \geq 255\text{ °C}$	–
peak temperature $T_{\text{peak}}$	250 °C +0/-5 °C
wetting temperature $T_{\text{min}}$	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature $T$	measured at solder pads

**Table 3:** Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 13:** Recommended reflow profile for convection and infrared soldering – lead-free solder.

## 13 Annotations

### 13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

### 13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

## 14 Cautions and warnings

### 14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under <https://rfe.qualcomm.com/>.

### 14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

### 14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

### 14.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

#### Projection method

Unless otherwise specified first-angle projection is applied.

## 15 Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (<https://rfe.qualcomm.com>). Should you have any more detailed questions, please contact our sales offices.
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